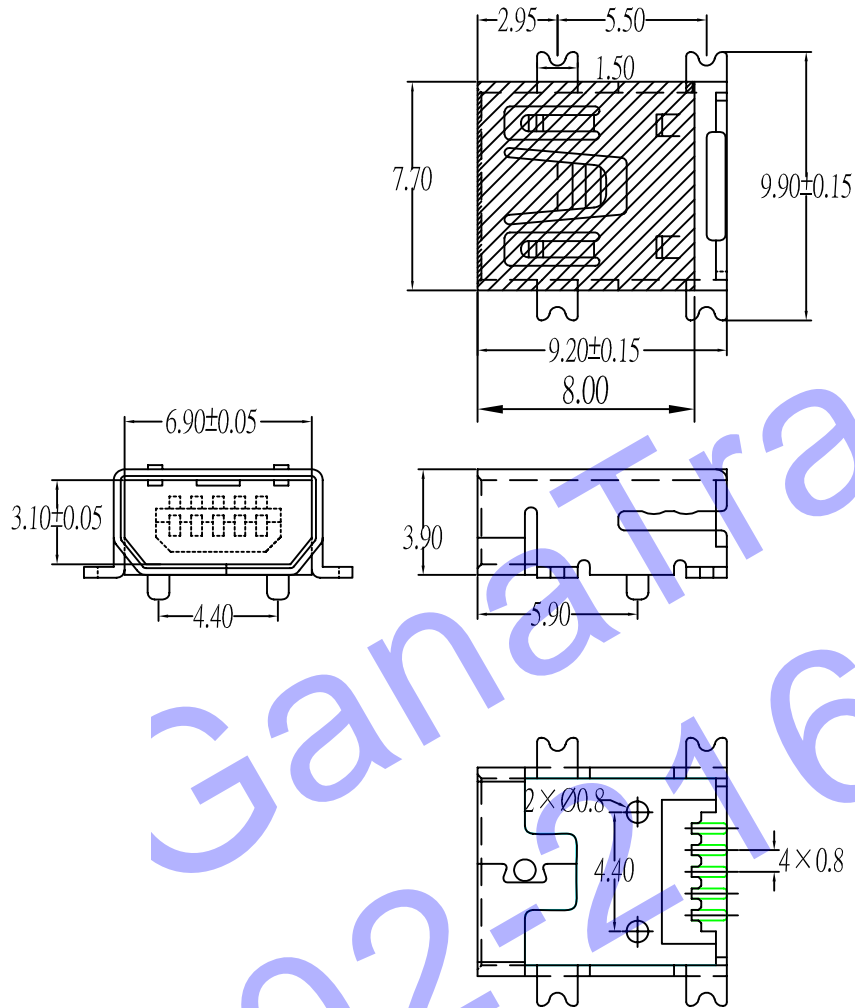


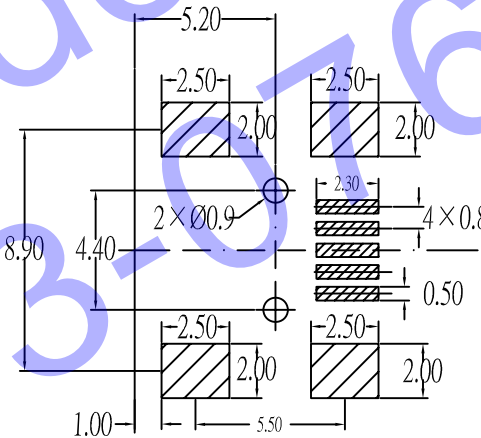
REV.	ECN NO.	DESCRIPTION	DRWN	APPD.	DATE



特性:Specifications:  
 电器:Electrical:  
 接触阻抗:Contact Resistance  
 50 milliohms MAX  
 耐电压:Dielectric Withstanding Voltage:  
 100 V AC AT Sea Level  
 绝缘阻抗:Insulation Resistance:  
 100 MEGA ohms MIN

材料:Material:  
 塑胶:Housing:Hing Temperature Thermoplastics,  
 UL 94V-0 耐高温塑胶  
 端子:Contact: Copper Alloy 铜合金  
 铁壳:Shell: Copper Alloy 铜合金  
 电镀:Finish:  
 端子:Contact: Plated Gold in Mating Area;  
 Tin On Solder Tails  
 接触点镀金.脚镀锡

Nickel/ Plating 镀镍



RECOMMENDED PCB LAYOUT

UNITS mm	SCALE 1:1	REV. A0	SHEET 1 OF 1	深圳市正耀科技有限公司 LITKCONN TECHNOLOGY CO., LTD.	
		DATE 2006-11-29	TITLE MINI USB 5P 母座AB型SMT		
GENERAL TOLERANCE 0.0 ±0.30 0.00 ±0.20 0.000 ±0.10 ANG ±1°		DR. <b>Leimeigui</b>	MAT'L SEE NOTES		FINISH SEE NOTES
APPD.		DRW.NO.	A	PART NO.	SIZE A4